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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







TJA1054A

Fault-tolerant CAN transceiver

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Product data sheet

1. General description

The TJA1054A is the interface between the protocol controller and the physical bus wires in a Controller Area Network (CAN). It is primarily intended for low-speed applications up to 125 kBd in passenger cars. The device provides differential receive and transmit capability but will switch to single-wire transmitter and/or receiver in error conditions.

The TJA1054A is the ElectroStatic Discharge (ESD) improved version of the TJA1054.

The TJA1054AT is, as the TJA1054T, pin and downwards compatible with the PCA82C252T and the TJA1053T. This means that these two devices can be replaced by the TJA1054AT or the TJA1054T with retention of all functions.

The most important improvements of the TJA1054 and the TJA1054A with respect to the PCA82C252 and the TJA1053 are:

- Very low ElectroMagnetic Emission (EME) due to a very good matching of the CANL and CANH output signals
- Good ElectroMagnetic Emission (EMI), especially in low power modes
- Full wake-up capability during bus failures
- Extended bus failure management including short-circuit of the CANH bus line to V_{CC}
- Support for easy system fault diagnosis
- Two-edge sensitive wake-up input signal via pin WAKE

2. Features and benefits

2.1 Optimized for in-car low-speed communication

- Baud rate up to 125 kBd
- Up to 32 nodes can be connected
- Supports unshielded bus wires
- Very low ElectroMagnetic Emission (EME) due to built-in slope control function and a very good matching of the CANL and CANH bus outputs
- Good ElectroMagnetic Immunity (EMI) in normal operating mode and in low power modes
- Fully integrated receiver filters
- Transmit Data (TxD) dominant time-out function

2.2 Bus failure management

Supports single-wire transmission modes with ground offset voltages up to 1.5 V



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- Automatic switching to single-wire mode in the event of bus failures, even when the CANH bus wire is short-circuited to V_{CC}
- Automatic reset to differential mode if bus failure is removed
- Full wake-up capability during failure modes

2.3 Protections

- Bus pins short-circuit safe to battery and to ground
- Thermally protected
- Bus lines protected against transients in an automotive environment
- An unpowered node does not disturb the bus lines

2.4 Support for low power modes

- Low-current sleep mode and standby mode with wake-up via the bus lines
- Power-on reset flag on the output

3. Quick reference data

Table 1. Quick reference data

 $V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}; V_{BAT} = 5.0 \text{ V to } 27 \text{ V}; V_{STB} = V_{CC}; T_{vj} = -40 ^{\circ}\text{C} \text{ to } +150 ^{\circ}\text{C};$ all voltages are defined with respect to ground; positive currents flow into the device; unless otherwise specified. [1][2][3]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------------|-----------------------------------|---|----------------|-----|------|------|
| V_{CC} | supply voltage | | 4.75 | - | 5.25 | V |
| V_{BAT} | battery supply voltage | no time limit | -0.3 | - | +40 | V |
| | on pin BAT | operating mode | 5.0 | - | 27 | V |
| | | load dump | - | - | 40 | V |
| I _{BAT} | battery supply current on pin BAT | sleep mode; $V_{CC} = 0 \text{ V}$; $V_{BAT} = 12 \text{ V}$ | - | 30 | 50 | μΑ |
| V _{CANH} | voltage on pin CANH | $\begin{split} &V_{CC}=0 \text{ V to } 5.0 \text{ V;} \\ &V_{BAT} \geq 0 \text{ V; no time limit;} \\ &\text{with respect to} \\ &\text{any other pin} \end{split}$ | –27 | - | +40 | V |
| V _{CANL} | voltage on pin CANL | $\begin{split} &V_{CC}=0 \text{ V to } 5.0 \text{ V;} \\ &V_{BAT} \geq 0 \text{ V; no time limit;} \\ &\text{with respect to} \\ &\text{any other pin} \end{split}$ | –27 | - | +40 | V |
| ΔV_{CANH} | voltage drop on pin CANH | $I_{CANH} = -40 \text{ mA}$ | - | - | 1.4 | V |
| ΔV_{CANL} | voltage drop on pin CANL | I _{CANL} = 40 mA | - | - | 1.4 | V |
| t _r | bus line output rise time | between 10 % and 90 %; C1 = 10 nF; see <u>Figure 5</u> | - | 0.6 | - | μS |
| t _f | bus line output fall time | between 10 % and 90 %; C1 = 1 nF; see <u>Figure 5</u> | - | 0.3 | - | μS |
| T_{vj} | virtual junction temperature | | <u>[4]</u> –40 | - | +150 | °C |

^[1] All parameters are guaranteed over the virtual junction temperature range by design, but only 100 % tested at T_{amb} = 125 °C for dies on wafer level, and above this for cased products 100 % tested at T_{amb} = 25 °C, unless otherwise specified.

^[2] For bare die, all parameters are only guaranteed if the back side of the die is connected to ground.

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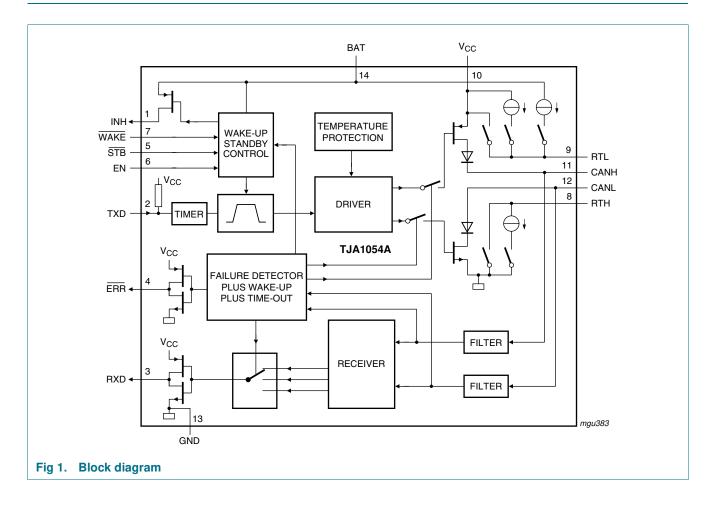
- [3] A local or remote wake-up event will be signalled at the transceiver pins RXD and $\overline{\text{ERR}}$ if $V_{\text{BAT}} = 5.3 \text{ V}$ to 27 V (see Table 5).
- [4] Junction temperature in accordance with "IEC 60747-1". An alternative definition is: $T_{vj} = T_{amb} + P \times R_{th(vj-a)}$ where $R_{th(vj-a)}$ is a fixed value to be used for the calculation of T_{vj} . The rating for T_{vj} limits the allowable combinations of power dissipation (P) and ambient temperature (T_{amb}) .

4. Ordering information

Table 2. Ordering information

| Type number | Package | | |
|----------------|---------|--|----------|
| | Name | Description | Version |
| TJA1054AT | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| TJA1054AT/S900 | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| TJA1054AU | - | bare die; 1990 µm \times 2730 µm \times 375 µm | - |

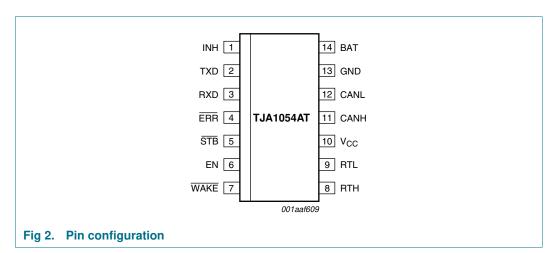
5. Block diagram



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6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

| Symbol | Pin | Description |
|----------|-----|--|
| INH | 1 | inhibit output for switching an external voltage regulator if a wake-up signal occurs |
| TXD | 2 | transmit data input for activating the driver to the bus lines |
| RXD | 3 | receive data output for reading out the data from the bus lines |
| ERR | 4 | error, wake-up and power-on indication output; active LOW in normal operating mode when a bus failure is detected; active LOW in standby and sleep mode when a wake-up is detected; active LOW in power-on standby when a V_{BAT} power-on event is detected |
| STB | 5 | standby digital control signal input; together with the input signal on pin EN this input determines the state of the transceiver; see Table 5 and Figure 3 |
| EN | 6 | enable digital control signal input; together with the input signal on pin STB this input determines the state of the transceiver; see Table 5 and Figure 3 |
| WAKE | 7 | local wake-up signal input (active LOW); both falling and rising edges are detected |
| RTH | 8 | termination resistor connection; in case of a CANH bus wire error the line is terminated with a predefined impedance |
| RTL | 9 | termination resistor connection; in case of a CANL bus wire error the line is terminated with a predefined impedance |
| V_{CC} | 10 | supply voltage |
| CANH | 11 | HIGH-level CAN bus line |
| CANL | 12 | LOW-level CAN bus line |
| GND | 13 | ground |
| BAT | 14 | battery supply voltage |

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7. Functional description

The TJA1054A is the interface between the CAN protocol controller and the physical wires of the CAN bus (see Figure 7). It is primarily intended for low-speed applications, up to 125 kBd, in passenger cars. The device provides differential transmit capability to the CAN bus and differential receive capability to the CAN controller.

To reduce EME, the rise and fall slopes are limited. This allows the use of an unshielded twisted pair or a parallel pair of wires for the bus lines. Moreover, the device supports transmission capability on either bus line if one of the wires is corrupted. The failure detection logic automatically selects a suitable transmission mode.

In normal operating mode (no wiring failures) the differential receiver is output on pin RXD (see <u>Figure 1</u>). The differential receiver inputs are connected to pins CANH and CANL through integrated filters. The filtered input signals are also used for the single-wire receivers. The receivers connected to pins CANH and CANL have threshold voltages that ensure a maximum noise margin in single-wire mode.

A timer function (TxD dominant time-out function) has been integrated to prevent the bus lines from being driven into a permanent dominant state (thus blocking the entire network communication) due to a situation in which pin TXD is permanently forced to a LOW level, caused by a hardware and/or software application failure.

If the duration of the LOW level on pin TXD exceeds a certain time, the transmitter will be disabled. The timer will be reset by a HIGH level on pin TXD.

7.1 Failure detector

The failure detector is fully active in the normal operating mode. After the detection of a single bus failure the detector switches to the appropriate mode (see <u>Table 4</u>). The differential receiver threshold voltage is set at -3.2 V typical ($V_{CC} = 5$ V). This ensures correct reception with a noise margin as high as possible in the normal operating mode and in the event of failures 1, 2, 5 and 6a. These failures, or recovery from them, do not destroy ongoing transmissions. The output drivers remain active, the termination does not change and the receiver remains in differential mode (see <u>Table 4</u>).

Failures 3, 3a and 6 are detected by comparators connected to the CANH and CANL bus lines. Failures 3 and 3a are detected in a two-step approach. If the CANH bus line exceeds a certain voltage level, the differential comparator signals a continuous dominant condition. Because of inter operability reasons with the predecessor products PCA82C252 and TJA1053, after a first time-out the transceiver switches to single-wire operation through CANH. If the CANH bus line is still exceeding the CANH detection voltage for a second time-out, the TJA1054A switches to CANL operation; the CANH driver is switched off and the RTH bias changes to the pull-down current source. The time-outs (delays) are needed to avoid false triggering by external RF fields.

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Table 4. Bus failures

| Failure | Description | Termination CANH (RTH) | Termination CANL (RTL) | CANH driver | CANL driver | Receiver mode |
|---------|---|------------------------|------------------------|----------------|----------------|---------------|
| 1 | CANH wire interrupted | on | on | on | on | differential |
| 2 | CANL wire interrupted | on | on | on | on | differential |
| 3 | CANH short-circuited to battery | weak ^[1] | on | off | on | CANL |
| 3a | CANH short-circuited to V _{CC} | weak ^[1] | on | off | on | CANL |
| 4 | CANL short-circuited to ground | on | weak[2] | on | off | CANH |
| 5 | CANH short-circuited to ground | on | on | on | on | differential |
| 6 | CANL short-circuited to battery | on | weak ^[2] | on | off | CANH |
| 6a | CANL short-circuited to V_{CC} | on | on | on | on | differential |
| 7 | CANL and CANH mutually short-circuited | on | weak ^[2] | on | off | CANH |

^[1] A weak termination implies a pull-down current source behavior of 75 µA typical.

Failure 6 is detected if the CANL bus line exceeds its comparator threshold for a certain period of time. This delay is needed to avoid false triggering by external RF fields. After detection of failure 6, the reception is switched to the single-wire mode through CANH; the CANL driver is switched off and the RTL bias changes to the pull-up current source.

Recovery from failures 3, 3a and 6 is detected automatically after reading a consecutive recessive level by corresponding comparators for a certain period of time.

Failures 4 and 7 initially result in a permanent dominant level on pin RXD. After a time-out the CANL driver is switched off and the RTL bias changes to the pull-up current source. Reception continues by switching to the single-wire mode via pins CANH or CANL. When failures 4 or 7 are removed, the recessive bus levels are restored. If the differential voltage remains below the recessive threshold level for a certain period of time, reception and transmission switch back to the differential mode.

If any of the wiring failure occurs, the output signal on pin \overline{ERR} will be set to LOW. On error recovery, the output signal on pin \overline{ERR} will be set to HIGH again. In case of an interrupted open bus wire, this failure will be detected and signalled only if there is an open wire between the transmitting and receiving node(s). Thus, during open wire failures, pin \overline{ERR} typically toggles.

During all single-wire transmissions, ElectroMagnetic Compatibility (EMC) performance (both immunity and emission) is worse than in the differential mode. The integrated receiver filters suppress any HF noise induced into the bus wires. The cut-off frequency of these filters is a compromise between propagation delay and HF suppression. In single-wire mode, LF noise cannot be distinguished from the required signal.

^[2] A weak termination implies a pull-up current source behavior of 75 μ A typical.

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7.2 Low power modes

The transceiver provides three low power modes which can be entered and exited via STB and EN (see Table 5 and Figure 3).

The sleep mode is the mode with the lowest power consumption. Pin INH is switched to HIGH-impedance for deactivation of the external voltage regulator. Pin CANL is biased to the battery voltage via pin RTL. If the supply voltage is provided, pins RXD and $\overline{\text{ERR}}$ will signal the wake-up interrupt.

The standby mode operates in the same way as the sleep mode but with a HIGH level on pin INH.

The power-on standby mode is the same as the standby mode, however, in this mode the battery power-on flag is shown on pin \overline{ERR} instead of the wake-up interrupt signal. The output on pin RXD will show the wake-up interrupt. This mode is only for reading out the power-on flag.

Table 5. Normal operating and low power modes

| Mode | Pin STB | Pin EN | Pin ERR | Pin ERR Pin R | | | Pin RTL |
|--------------------|---------|--------|--|------------------|---|-------------------------------|------------------|
| | | | LOW | HIGH | LOW | HIGH | switched to |
| Goto-sleep command | LOW | HIGH | wake-up interrupt | | wake-up interrupt | | V_{BAT} |
| Sleep | LOW | LOW[4] | signal [1][2][3] | | signal [1][2][3] | | |
| Standby | LOW | LOW | _ <u>C1C1/-1</u> | | <u>Cacara</u> | | |
| Power-on standby | HIGH | LOW | V _{BAT} power-on flag ^{[1][5]} | | wake-up interrupt signal [1][2][3] | | V _{BAT} |
| Normal operating | HIGH | HIGH | error flag | no error flag | dominant received data | recessive received data | V _{CC} |

^[1] If the supply voltage V_{CC} is present.

Wake-up requests are recognized by the transceiver through two possible channels:

- The bus lines for remote wake-up
- Pin WAKE for local wake-up

In order to wake-up the transceiver remotely through the bus lines, a filter mechanism is integrated. This mechanism makes sure that noise and any present bus failure conditions do not result into an erroneous wake-up. Because of this mechanism it is not sufficient to simply pull the CANH or CANL bus lines to a dominant level for a certain time. To guarantee a successful remote wake-up under all conditions, a message frame with a dominant phase of at least the maximum specified $t_{(CANH)}$ or $t_{(CANL)}$ in it is required.

^[2] Wake-up interrupts are released when entering normal operating mode.

^[3] A local or remote wake-up event will be signalled at the transceiver pins RXD and $\overline{\text{ERR}}$ if $V_{BAT} = 5.3 \text{ V}$ to 27 V.

^[4] In case the goto-sleep command was used before. When V_{CC} drops, pin EN will become LOW, but due to the fail-safe functionality this does not effect the internal functions.

^[5] V_{BAT} power-on flag will be reset when entering normal operating mode.

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A local wake-up through pin $\overline{\text{WAKE}}$ is detected by a rising or falling edge with a consecutive level exceeding the maximum specified t_{WAKE} .

On a wake-up request the transceiver will set the output on pin INH to HIGH which can be used to activate the external supply voltage regulator.

If V_{CC} is provided the wake-up request can be read on the \overline{ERR} or RXD outputs, so the external microcontroller can activate the transceiver (switch to normal operating mode) via pins \overline{STB} and EN.

To prevent a false remote wake-up due to transients or RF fields, the wake-up voltage levels have to be maintained for a certain period of time. In the low power modes the failure detection circuit remains partly active to prevent an increased power consumption in the event of failures 3, 3a, 4 and 7.

To prevent a false local wake-up during an open wire at pin \overline{WAKE} , this pin has a weak pull-up current source towards V_{BAT} . However, in order to protect the transceiver against any EMC immunity issues, it is recommended to connect a not used pin \overline{WAKE} to pin BAT. Pin INH is set to floating only if the goto-sleep command is entered successfully. To enter a successful goto-sleep command under all conditions, this command must be kept stable for the maximum specified $t_{h(sleep)}$.

Pin INH will be set to a HIGH level again by the following events only:

- V_{BAT} power-on (cold start)
- Rising or falling edge on pin WAKE
- A message frame with a dominant phase of at least the maximum specified t_(CANH) or t_(CANL), while pin EN or pin STB is at a LOW level
- Pin STB goes to a HIGH level with V_{CC} active

To provide fail-safe functionality, the signals on pins \overline{STB} and EN will internally be set to LOW when V_{CC} is below a certain threshold voltage ($V_{CC(stb)}$).

7.3 Power-on

After power-on (V_{BAT} switched on) the signal on pin INH will become HIGH and an internal power-on flag will be set. This flag can be read in the power-on standby mode through pin \overline{ERR} (\overline{STB} = HIGH; EN = LOW) and will be reset by entering the normal operating mode.

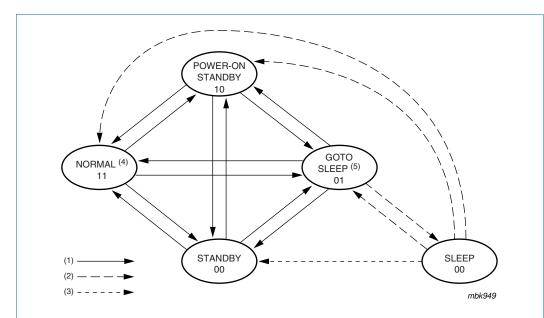
7.4 Protections

A current limiting circuit protects the transmitter output stages against short-circuit to positive and negative battery voltage.

If the junction temperature exceeds the typical value of 165 °C, the transmitter output stages are disabled. Because the transmitter is responsible for the major part of the power dissipation, this will result in a reduced power dissipation and hence a lower chip temperature. All other parts of the device will continue to operate.

The pins CANH and CANL are protected against electrical transients which may occur in an automotive environment.

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Mode 10 stands for: Pin \overline{STB} = HIGH and pin EN = LOW.

- (1) Mode change via input pins STB and EN.
- (2) Mode change via input pins STB and EN; it should be noted that in the sleep mode pin INH is inactive and possibly there is no V_{CC}. Mode control is only possible if V_{CC} of the transceiver is active.
- (3) Pin INH is activated after wake-up via bus input pin WAKE.
- (4) Transitions to normal mode clear the internal wake-up: interrupt and battery fail flag are
- (5) Transitions to sleep mode: pin INH is deactivated.

Fig 3. Mode control

8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-------------------|---|-------------------------------|------------|----------------|------|
| V_{CC} | supply voltage | | -0.3 | +6 | V |
| V_{BAT} | battery supply voltage | | -0.3 | +40 | V |
| V_{TXD} | voltage on pin TXD | | -0.3 | $V_{CC} + 0.3$ | V |
| V_{RXD} | voltage on pin RXD | | -0.3 | $V_{CC} + 0.3$ | V |
| V_{ERR} | voltage on pin \overline{ERR} | | -0.3 | $V_{CC} + 0.3$ | V |
| V_{STB} | voltage on pin $\overline{\text{STB}}$ | | -0.3 | $V_{CC} + 0.3$ | V |
| V_{EN} | voltage on pin EN | | -0.3 | $V_{CC} + 0.3$ | V |
| V _{CANH} | voltage on pin CANH | with respect to any other pin | -27 | +40 | V |
| V _{CANL} | voltage on pin CANL | with respect to any other pin | –27 | +40 | V |
| $V_{trt(n)}$ | transient voltage on pins CANH and CANL | see <u>Figure 6</u> | -150 | +100 | V |

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Table 6. Limiting values ...continued
In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|-----------------------------------|---------------------------------|----------------|------------------------|------|
| $V_{I(\text{WAKE})}$ | input voltage on pin WAKE | with respect to any other pin | - | $V_{BAT} + 0.3$ | V |
| I _{I(WAKE)} | input current on pin WAKE | | <u>[2]</u> –15 | - | mΑ |
| V _{INH} | voltage on pin INH | | -0.3 | $V_{BAT} + 0.3$ | V |
| V _{RTH} | voltage on pin RTH | with respect to any other pin | -0.3 | V _{BAT} + 1.2 | V |
| V _{RTL} | voltage on pin RTL | with respect to any other pin | -0.3 | V _{BAT} + 1.2 | V |
| R _{RTH} | termination resistance on pin RTH | | 500 | 16000 | Ω |
| R _{RTL} | termination resistance on pin RTL | | 500 | 16000 | Ω |
| T _{vj} | virtual junction temperature | | <u>[3]</u> −40 | +150 | °C |
| T _{stg} | storage temperature | | -55 | +150 | °C |
| V _{ESD} | electrostatic discharge | human body model | [4] | | |
| | voltage | pins RTH, RTL, CANH and CANL | -4 | +4 | kV |
| | | all other pins | -2 | +2 | kV |
| | | machine model | [5] | | |
| | | any pin | -150 | +150 | V |

^[1] All voltages are defined with respect to pin GND, unless otherwise specified. Positive current flows into the

9. Thermal characteristics

Table 7. Thermal characteristics

| Symbol | Parameter | Conditions | Тур | Unit |
|----------------------|--|-------------|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | 120 | K/W |
| R _{th(j-s)} | thermal resistance from junction to substrate bare die | in free air | 40 | K/W |

^[2] Only relevant if $V_{WAKE} < V_{GND} - 0.3 V$; current will flow into pin GND.

^[3] Junction temperature in accordance with "IEC 60747-1". An alternative definition is: $T_{vj} = T_{amb} + P \times R_{th(vj-a)}$ where $R_{th(vj-a)}$ is a fixed value to be used for the calculation of T_{vj} . The rating for T_{vj} limits the allowable combinations of power dissipation (P) and ambient temperature (T_{amb}).

^[4] Equivalent to discharging a 100 pF capacitor through a 1.5 k Ω resistor.

^[5] Equivalent to discharging a 200 pF capacitor through a 10 Ω resistor and a 0.75 μ H coil.

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10. Static characteristics

Table 8. Static characteristics

 $V_{CC} = 4.75 \text{ V}$ to 5.25 V; $V_{BAT} = 5.0 \text{ V}$ to 27 V; $V_{STB} = V_{CC}$; $T_{Vj} = -40 \,^{\circ}\text{C}$ to $+150 \,^{\circ}\text{C}$; all voltages are defined with respect to ground; positive currents flow into the device; unless otherwise specified. [1][2][3]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--|---|--------------------|------|--------------------|------|
| Supplies (| pins V _{CC} and BAT) | | | | | |
| V _{CC} | supply voltage | | 4.75 | - | 5.25 | V |
| V _{CC(stb)} | supply voltage for forced standby mode (fail-safe) | | 2.75 | - | 4.5 | V |
| I _{CC} | supply current | normal operating mode; $V_{TXD} = V_{CC}$ (recessive) | 4 | 7 | 11 | mA |
| | | normal operating mode; $V_{TXD} = 0 V \text{ (dominant)}; \text{ no load}$ | 10 | 17 | 27 | mA |
| | | low power modes at $V_{TXD} = V_{CC}$ | 0 | 0 | 10 | μΑ |
| V _{BAT} | battery supply voltage | no time limit | -0.3 | - | +40 | V |
| | on pin BAT | operating mode | 5.0 | - | 27 | ٧ |
| | | load dump | - | - | 40 | V |
| I _{BAT} | battery supply current on pin BAT | low power mode at $V_{RTL} = V_{WAKE} = V_{INH} = V_{BAT}$ | | | | |
| | | $V_{BAT} = 12 \text{ V}$ | 10 | 30 | 50 | μΑ |
| | | $V_{BAT} = 5 V \text{ to } 27 V$ | 5 | 30 | 125 | μΑ |
| | | $V_{BAT} = 3.5 V$ | 5 | 20 | 30 | μΑ |
| | | V _{BAT} = 1 V | 0 | 0 | 10 | μΑ |
| | | sleep mode; $V_{CC} = 0 \text{ V}$; $V_{BAT} = 12 \text{ V}$ | - | 30 | 50 | μА |
| $V_{pof(BAT)}$ | power-on flag voltage on pin BAT | low power modes | | | | |
| | | power-on flag set | - | - | 1 | V |
| | | power-on flag not set | 3.5 | - | - | V |
| I _(tot) | total supply current | low power modes; $V_{CC} = 5 \text{ V}$; $V_{BAT} = V_{WAKE} = V_{INH} = 12 \text{ V}$ | - | 30 | 60 | μА |
| Pins STB, | EN and TXD | | | | | |
| V _{IH} | HIGH-level input voltage | | 0.7V _{CC} | - | $V_{CC} + 0.3$ | V |
| V _{IL} | LOW-level input voltage | | -0.3 | - | 0.3V _{CC} | V |
| IH | HIGH-level input current | | | | | |
| | pins STB and EN | $V_I = 4 V$ | - | 9 | 20 | μΑ |
| | pin TXD | $V_I = 4 V$ | -200 | -80 | -25 | μΑ |
| lıL | LOW-level input current | | | | | |
| | pins STB and EN | $V_I = 1 V$ | 4 | 8 | - | μΑ |
| | pin TXD | V _I = 1 V | -800 | -320 | -100 | μА |
| | | | | | | |

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 Table 8.
 Static characteristics ...continued

 $V_{CC} = 4.75 \text{ V}$ to 5.25 V; $V_{BAT} = 5.0 \text{ V}$ to 27 V; $V_{STB} = V_{CC}$; $T_{Vj} = -40 \,^{\circ}\text{C}$ to $+150 \,^{\circ}\text{C}$; all voltages are defined with respect to ground; positive currents flow into the device; unless otherwise specified. [1][2][3]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---|--|-----------------------|----------------------|----------------------|------|
| Pins RXD a | ind ERR | | | | | |
| V _{OH} | HIGH-level output voltage | | | | | |
| | on pin \overline{ERR} | $I_O = -100 \mu A$ | $V_{CC}-0.9$ | - | V_{CC} | V |
| | on pin RXD | $I_O = -1 \text{ mA}$ | $V_{CC}-0.9$ | - | V_{CC} | V |
| V _{OL} | LOW-level output voltage | | | | | |
| | on pin ERR | I _O = 1.6 mA | 0 | - | 0.4 | V |
| | on pin RXD | I _O = 7.5 mA | 0 | - | 1.5 | V |
| Pin WAKE | | | | | | |
| I _{IL} | LOW-level input current | $V_{WAKE} = 0 V; V_{BAT} = 27 V$ | -10 | -4 | –1 | μА |
| $V_{th(wake)}$ | wake-up threshold voltage | V _{STB} = 0 V | 2.5 | 3.2 | 3.9 | V |
| Pin INH | | | | | | |
| ΔV_H | HIGH-level voltage drop | $I_{INH} = -0.18 \text{ mA}$ | - | - | 0.8 | V |
| I _L | leakage current | sleep mode; V _{INH} = 0 V | - | - | 5 | μА |
| Pins CANH | and CANL | | | | | |
| V _{CANH} | voltage on pin CANH | V_{CC} = 0 V to 5.0 V; $V_{BAT} \ge 0$ V; no time limit; with respect to any other pin | - 27 | - | +40 | V |
| V _{CANL} | voltage on pin CANL | V_{CC} = 0 V to 5.0 V; $V_{BAT} \ge 0$ V; no time limit; with respect to any other pin | –27 | - | +40 | V |
| ΔV_{CANH} | voltage drop on pin CANH | $I_{CANH} = -40 \text{ mA}$ | - | - | 1.4 | V |
| ΔV_{CANL} | voltage drop on pin CANL | I _{CANL} = 40 mA | - | - | 1.4 | V |
| $V_{th(dif)}$ | differential receiver threshold voltage | no failures and bus failures 1, 2, 5 and 6a; see <u>Figure 4</u> | | | | |
| | | V _{CC} = 5 V | -3.5 | -3.2 | -2.9 | ٧ |
| | | V _{CC} = 4.75 V to 5.25 V | -0.70V _{CC} | -0.64V _{CC} | -0.58V _{CC} | V |
| V _{O(reces)} | recessive output voltage | $V_{TXD} = V_{CC}$ | | | | |
| | on pin CANH | R _{RTH} < 4 kΩ | - | - | 0.2 | ٧ |
| | on pin CANL | $R_{RTL} < 4 \text{ k}\Omega$ | $V_{CC}-0.2$ | - | - | ٧ |
| $V_{O(dom)}$ | dominant output voltage | $V_{TXD} = 0 V; V_{EN} = V_{CC}$ | | | | |
| | on pin CANH | $I_{CANH} = -40 \text{ mA}$ | V _{CC} – 1.4 | - | - | V |
| | on pin CANL | I _{CANL} = 40 mA | - | | 1.4 | V |

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 Table 8.
 Static characteristics ...continued

 $V_{CC} = 4.75 \text{ V}$ to 5.25 V; $V_{BAT} = 5.0 \text{ V}$ to 27 V; $V_{STB} = V_{CC}$; $T_{Vj} = -40 \,^{\circ}\text{C}$ to $+150 \,^{\circ}\text{C}$; all voltages are defined with respect to ground; positive currents flow into the device; unless otherwise specified. [1][2][3]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------------|---|--|---------------------|---------------------|---------------------|------|
| I _{O(CANH)} | output current on pin CANH | normal operating mode; $V_{CANH} = 0 V$; $V_{TXD} = 0 V$ | - 110 | -80 | –45 | mA |
| | | low power modes; $V_{CANH} = 0 \text{ V}; V_{CC} = 5 \text{ V}$ | - | -0.25 | - | μΑ |
| I _{O(CANL)} | output current on pin CANL | normal operating mode; $V_{CANL} = 14 \text{ V}; V_{TXD} = 0 \text{ V}$ | 45 | 70 | 100 | mA |
| | | low power modes; $V_{CANL} = 12 \text{ V}; V_{BAT} = 12 \text{ V}$ | - | 0 | - | μА |
| V _{d(CANH)(sc)} | detection voltage for short-circuit to battery | normal operating mode; $V_{CC} = 5 V$ | 1.5 | 1.7 | 1.85 | V |
| | voltage on pin CANH | low power modes | 1.1 | 1.8 | 2.5 | V |
| $V_{d(CANL)(sc)}$ | detection voltage for | normal operating mode | | | | |
| | short-circuit to battery voltage on pin CANL | $V_{CC} = 5 V$ | 6.6 | 7.2 | 7.8 | V |
| | Vollage on pin OANL | $V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}$ | 1.32V _{CC} | 1.44V _{CC} | 1.56V _{CC} | V |
| $V_{\text{th(wake)}}$ | wake-up threshold voltage | | | | | |
| | on pin CANL | low power modes | 2.5 | 3.2 | 3.9 | V |
| | on pin CANH | low power modes | 1.1 | 1.8 | 2.5 | V |
| $\Delta V_{th(wake)}$ | difference of wake-up threshold voltages (on pins CANL and CANH) | low power modes | 0.8 | 1.4 | - | V |
| V _{th(CANH)(se)} | single-ended receiver threshold voltage on | normal operating mode and failures 4, 6 and 7 | | | | |
| | pin CANH | $V_{CC} = 5 V$ | 1.5 | 1.7 | 1.85 | V |
| | | $V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}$ | 0.30V _{CC} | $0.34V_{CC}$ | $0.37V_{CC}$ | V |
| $V_{th(CANL)(se)}$ | single-ended receiver threshold voltage on | normal operating mode and failures 3 and 3a | | | | |
| | pin CANL | V _{CC} = 5 V | 3.15 | 3.3 | 3.45 | V |
| | | $V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}$ | 0.63V _{CC} | $0.66V_{CC}$ | $0.69V_{CC}$ | V |
| R _{i(CANH)(se)} | single-ended input resistance on pin CANH | normal operating mode | 110 | 165 | 270 | kΩ |
| R _{i(CANL)(se)} | single-ended input resistance on pin CANL | normal operating mode | 110 | 165 | 270 | kΩ |
| $R_{i(dif)}$ | differential input resistance | normal operating mode | 220 | 330 | 540 | kΩ |
| Pins RTH an | nd RTL | | | | | |
| $R_{sw(RTL)}$ | switch-on resistance on pin RTL | normal operating mode; $ I_O < 10 \text{ mA}$ | - | 50 | 100 | Ω |
| $R_{sw(RTH)}$ | switch-on resistance on pin RTH | normal operating mode; $ I_O < 10 \text{ mA}$ | - | 50 | 100 | Ω |

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Table 8. Static characteristics ... continued

 $V_{CC} = 4.75 \text{ V}$ to 5.25 V; $V_{BAT} = 5.0 \text{ V}$ to 27 V; $V_{STB} = V_{CC}$; $T_{vj} = -40 ^{\circ}\text{C}$ to $+150 ^{\circ}\text{C}$; all voltages are defined with respect to ground; positive currents flow into the device; unless otherwise specified. [1][2][3]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|---------------------------------|---|-------|-------|------|------|
| $V_{O(RTH)}$ | output voltage on pin RTH | low power modes; $I_O = 1 \text{ mA}$ | - | 0.7 | 1.0 | V |
| I _{O(RTL)} | output current on pin RTL | low power modes; $V_{RTL} = 0 V$ | -1.25 | -0.65 | -0.3 | mA |
| $I_{pu(RTL)}$ | pull-up current on pin RTL | normal operating mode and failures 4, 6 and 7 | - | 75 | - | μΑ |
| $I_{pd(RTH)}$ | pull-down current on pin RTH | normal operating mode and failures 3 and 3a | - | 75 | - | μА |
| Thermal sl | nutdown | | | | | |
| $T_{j(sd)}$ | shutdown junction temperature | | 155 | 165 | 180 | °C |

^[1] All parameters are guaranteed over the virtual junction temperature range by design, but only 100 % tested at T_{amb} = 125 °C for dies on wafer level, and above this for cased products 100 % tested at T_{amb} = 25 °C, unless otherwise specified.

11. Dynamic characteristics

Table 9. Dynamic characteristics

 V_{CC} = 4.75 V to 5.25 V; V_{BAT} = 5.0 V to 27 V; V_{STB} = V_{CC} ; T_{vj} = -40 °C to +150 °C; all voltages are defined with respect to ground; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---|--|---|------|------|------|------|
| $t_{t(reces\text{-}dom)}$ | transition time for recessive to dominant (on pins CANL and CANH) | between 10 % and 90 %; R = 100 Ω ; C1 = 10 nF; C2 = not present; see Figure 5 | 0.35 | 0.60 | - | μS |
| $t_{t(dom\text{-reces})}$ | transition time for dominant to recessive (on pins CANL and CANH) | between 10 % and 90 %; $R = 100 \Omega$; $C1 = 1 nF$; C2 = not present; $SEE = \frac{1}{2} \frac{1}{2$ | 0.2 | 0.3 | - | μ\$ |
| t _{PD(L)} propagation delay TXD (LOW) to RXD (LOW) | | no failures and failures 1, 2, 5 and 6a; R = 100Ω ; see Figure 4 and Figure 5 | | | | |
| | | C1 = 1 nF; C2 = not present | - | 0.75 | 1.5 | μS |
| | | C1 = C2 = 3.3 nF | - | 1 | 1.75 | μS |
| | | failures 3, 3a, 4, 6 and 7; $R = 100 \Omega$; see Figure 4 and Figure 5 | | | | |
| | | C1 = 1 nF; C2 = not present | - | 0.85 | 1.4 | μS |
| | C1 = C2 = 3.3 nF | | - | 1.1 | 1.7 | μS |

^[2] For bare die, all parameters are only guaranteed if the back side of the die is connected to ground.

^[3] A local or remote wake-up event will be signalled at the transceiver pins RXD and $\overline{\text{ERR}}$ if $V_{BAT} = 5.3 \text{ V}$ to 27 V (see Table 5).

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Table 9. Dynamic characteristics ...continued $V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}; V_{BAT} = 5.0 \text{ V to } 27 \text{ V}; V_{STB} = V_{CC}; T_{vj} = -40 ^{\circ}\text{C} \text{ to } +150 ^{\circ}\text{C}; \text{ all voltages are defined with respect to ground; unless otherwise specified.}$

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---------------------------|--|---|-----|------|-----|-----|------|
| t _{PD(H)} | propagation delay TXD (HIGH) to RXD (HIGH) | no failures and failures 1, 2, 5 and 6a; R = 100 Ω ; see Figure 4 and Figure 5 | | | | | |
| | | C1 = 1 nF; C2 = not present | | - | 1.2 | 1.9 | μS |
| | | C1 = C2 = 3.3 nF | | - | 2.5 | 3.3 | μS |
| | | failures 3, 3a, 4, 6 and 7; $R = 100 \Omega$; see Figure 4 and Figure 5 | | | | | |
| | | C1 = 1 nF; C2 = not present | | - | 1.1 | 1.7 | μS |
| | | C1 = C2 = 3.3 nF | | - | 1.5 | 2.2 | μS |
| t _r | bus line output rise time | between 10 % and 90 %; C1 = 10 nF; see <u>Figure 5</u> | | - | 0.6 | - | μS |
| t _f | bus line output fall time | between 10 % and 90 %; C1 = 1 nF; see Figure 5 | | - | 0.3 | - | μS |
| t _{react(sleep)} | reaction time of goto-sleep command | | | 5 | - | 50 | μS |
| t _{dis(TxD)} | disable time of TxD permanent dominant timer | normal operating mode; $V_{TXD} = 0 V$ | | 0.75 | - | 4 | ms |
| t _{dom(CANH)} | dominant time for remote wake-up on pin CANH | low power modes; V _{BAT} = 12 V | [4] | 7 | - | 38 | μS |
| t _{dom(CANL)} | dominant time for remote wake-up on pin CANL | low power modes; V _{BAT} = 12 V | [4] | 7 | - | 38 | μS |
| t _{WAKE} | req <u>uired ti</u> me on pin WAKE for local wake-up | low power modes; V _{BAT} = 12 V; for wake-up after receiving a falling or rising edge | [4] | 7 | - | 38 | μ\$ |
| t _{det} | failure detection time | normal operating mode | | | | | |
| | | failures 3 and 3a | | 1.6 | - | 8.0 | ms |
| | | failures 4, 6 and 7 | | 0.3 | - | 1.6 | ms |
| | | low power modes; V _{BAT} = 12 V | | | | | |
| | | failures 3 and 3a | | 1.6 | - | 8.0 | ms |
| | | failures 4 and 7 | | 0.1 | - | 1.6 | ms |

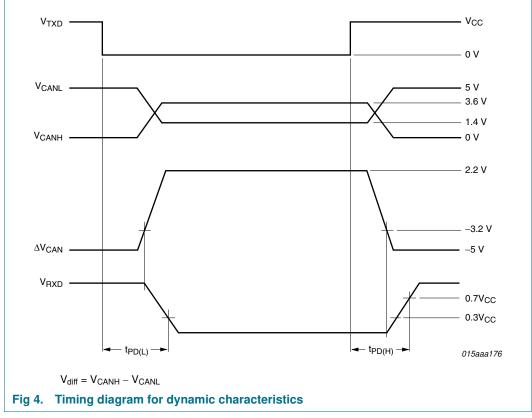
Fault-tolerant CAN transceiver

 Table 9.
 Dynamic characteristics ...continued

 $V_{CC} = 4.75 \text{ V}$ to 5.25 V; $V_{BAT} = 5.0 \text{ V}$ to 27 V; $V_{STB} = V_{CC}$; $T_{vj} = -40 ^{\circ}\text{C}$ to $+150 ^{\circ}\text{C}$; all voltages are defined with respect to ground; unless otherwise specified. [1][2][3]

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|---|--|-----|-----|-----|------|
| t _{rec} | failure recovery time | normal operating mode | | | | |
| | | failures 3 and 3a | 0.3 | - | 1.6 | ms |
| | | failures 4 and 7 | 7 | - | 38 | μS |
| | | failure 6 | 125 | - | 750 | μS |
| | | low power modes; V _{BAT} = 12 V | | | | |
| | | failures 3, 3a, 4 and 7 | 0.3 | - | 1.6 | ms |
| n _{det} | pulse-count failure detection | difference between CANH and CANL; normal operating mode and failures 1, 2, 5 and 6a; pin ERR becomes LOW | - | 4 | - | |
| n _{rec} | number of consecutive pulses for failure recovery | on CANH and CANL simultaneously; failures 1, 2, 5 and 6a | - | 4 | - | |

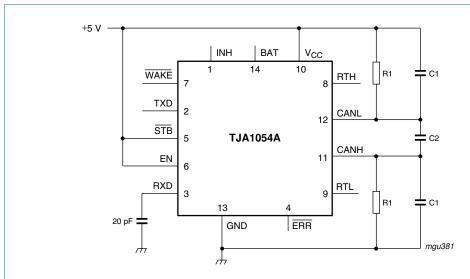
- [1] All parameters are guaranteed over the virtual junction temperature range by design, but only 100 % tested at T_{amb} = 125 °C for dies on wafer level, and above this for cased products 100 % tested at T_{amb} = 25 °C, unless otherwise specified.
- [2] For bare die, all parameters are only guaranteed if the back side of the die is connected to ground.
- [3] A local or remote wake-up event will be signalled at the transceiver pins RXD and ERR if V_{BAT} = 5.3 V to 27 V (see Table 4).
- [4] To guarantee a successful mode transition under all conditions, the maximum specified time must be applied.



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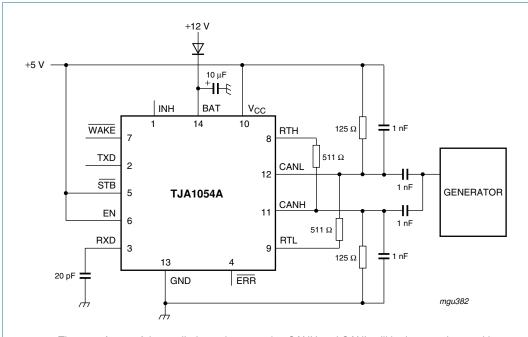
12. Test information



Termination resistors R1 (100 Ω) are not connected to pin RTH or pin RTL for testing purposes because the minimum load allowed on the CAN bus lines is 500 Ω per transceiver.

The capacitive bus load of 10 nF is split into 3 equal capacitors (3.3 nF) to simulate the bus cable.

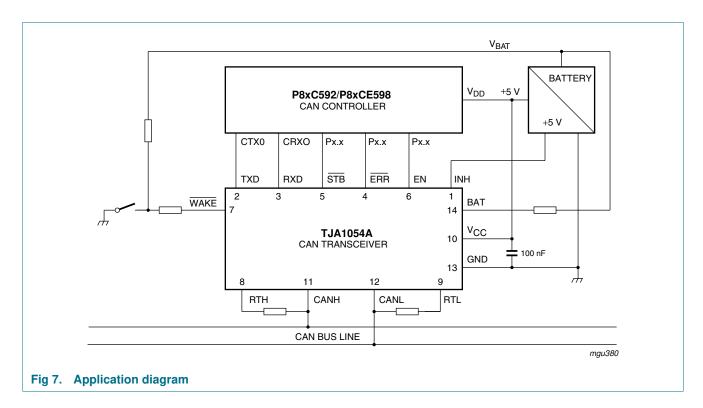
Fig 5. Test circuit for dynamic characteristics



The waveforms of the applied transients on pins CANH and CANL will be in accordance with "ISO 7637 part 1": test pulses 1, 2, 3a and 3b.

Fig 6. Test circuit for automotive transients

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12.1 Quality information

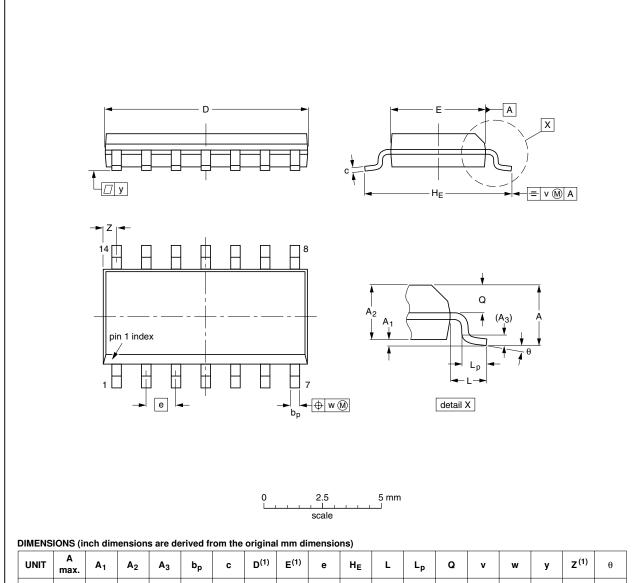
This product has been qualified to the appropriate Automotive Electronics Council (AEC) standard Q100 or Q101 and is suitable for use in automotive applications.

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13. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|--------|-----------|----------------|----------------|----------------|--------------|------------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----|
| mm | 1.75 | 0.25 0.10 | 1.45 1.25 | 0.25 | 0.49 0.36 | 0.25 0.19 | 8.75 8.55 | 4.0 3.8 | 1.27 | 6.2 5.8 | 1.05 | 1.0 0.4 | 0.7 0.6 | 0.25 | 0.25 | 0.1 | 0.7 0.3 | 8° |
| inches | 0.069 | 0.010 0.004 | 0.057 0.049 | 0.01 | l | 0.0100 0.0075 | | 0.16 0.15 | 0.05 | 0.244 0.228 | 0.041 | 0.039 0.016 | 0.028 0.024 | 0.01 | 0.01 | 0.004 | 0.028 0.012 | 0° |

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| | REFER | ENCES | EUROPEAN ISSUE DATI | | |
|--------|--------|-----------|---------------------|---------------------------------|--|
| IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE | |
| 076E06 | MS-012 | | | 99-12-27 03-02-19 | |
| | _ | IEC JEDEC | IEC JEDEC JEITA | IEC JEDEC JEITA PROJECTION | |

Fig 8. Package outline SOT108-1 (SO14)

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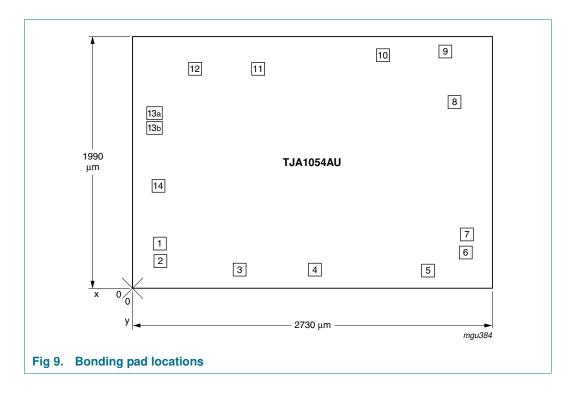
Fault-tolerant CAN transceiver

14. Bare die outline

Table 10. Bonding pad locations

| Symbol | Pad | Coordinates[1] | |
|-----------------|-----|----------------|------|
| | | х | у |
| INH | 1 | 106 | 317 |
| TXD | 2 | 111 | 168 |
| RXD | 3 | 750 | 111 |
| ERR | 4 | 1347 | 111 |
| STB | 5 | 2248 | 103 |
| EN | 6 | 2551 | 240 |
| WAKE | 7 | 2559 | 381 |
| RTH | 8 | 2463 | 1443 |
| RTL | 9 | 2389 | 1840 |
| V _{CC} | 10 | 1886 | 1809 |
| CANH | 11 | 900 | 1698 |
| CANL | 12 | 401 | 1698 |
| GND | 13a | 80 | 1356 |
| GND | 13b | 80 | 1241 |
| BAT | 14 | 105 | 772 |

All coordinates (μm) represent the position of the center of each pad with respect to the bottom left-hand corner of the top aluminium layer (see Figure 9).



Fault-tolerant CAN transceiver

15. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

15.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

15.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- · Through-hole components
- · Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- · Package placement
- · Inspection and repair
- · Lead-free soldering versus SnPb soldering

15.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

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15.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 10</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 11 and 12

Table 11. SnPb eutectic process (from J-STD-020C)

| Package thickness (mm) | Package reflow temperature (°C) | | |
|------------------------|---------------------------------|-------|--|
| | Volume (mm ³) | | |
| | < 350 | ≥ 350 | |
| < 2.5 | 235 | 220 | |
| ≥ 2.5 | 220 | 220 | |

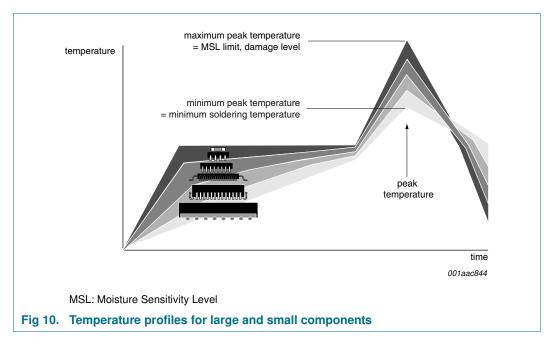
Table 12. Lead-free process (from J-STD-020C)

| Package thickness (mm) | Package reflow temperature (°C) | | | | | |
|------------------------|---------------------------------|-----|-----|--|--|--|
| | Volume (mm ³) | | | | | |
| | < 350 350 to 2000 > 2000 | | | | | |
| < 1.6 | 260 | 260 | 260 | | | |
| 1.6 to 2.5 | 260 | 250 | 245 | | | |
| > 2.5 | 250 245 245 | | | | | |

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 10.

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For further information on temperature profiles, refer to Application Note *AN10365* "Surface mount reflow soldering description".

16. Appendix

16.1 Overview of differences between the TJA1054 and the TJA1054A

Table 13. Characteristics

| Symbol | Parameter | Conditions | TJA | 1054 | TJA1054A | | Unit |
|-------------------|----------------------------|------------------------------------|------|------|----------|------|------|
| | | | Min | Max | Min | Max | |
| V_{CANH} | CANH bus line voltage | | -40 | +40 | -27 | +40 | V |
| V _{CANL} | CANL bus line voltage | | -40 | +40 | -27 | +40 | V |
| V _{ESD} | electrostatic discharge | human body model | | | | | |
| | voltage | pins RTH, RTL, CANH and CANL | -2 | +2 | -4 | +4 | kV |
| | | all other pins | -2 | +2 | -2 | +2 | kV |
| | | machine model | | | | | |
| | | any pin | -100 | +100 | -150 | +150 | V |

Table 14. Bare die

| Parameter | TJA1054 | TJA1054A | Unit |
|-------------------------|------------------|------------------|------|
| Dimensions | 1990×2700 | 1990×2730 | μm |
| Bonding pad coordinates | <u>[1]</u> | <u>[1]</u> | |

^[1] The bonding pad coordinates partly differ between the TJA1054 and the TJA1054A.

Fault-tolerant CAN transceiver

17. Abbreviations

Table 15. Abbreviations

| Acronym | Description |
|---------|-------------------------------|
| CAN | Controller Area Network |
| EMC | ElectroMagnetic Compatibility |
| EME | ElectroMagnetic Emission |
| EMI | ElectroMagnetic Immunity |
| ESD | ElectroStatic Discharge |

18. Revision history

Table 16. Revision history

| Release date | Data sheet status | Change notice | Supersedes |
|-----------------------------------|---|---|--|
| 20100803 | Product data sheet | - | TJA1054A_4 |
| Value of para | ameter V _{ESD} (machine model) | changed in <u>Table 6</u> a | and <u>Table 13</u> . |
| Typing error | corrected in <u>Table 8</u> in the con | ditions column for I _B | AT- |
| 20070102 | Product data sheet | - | TJA1054A_3 |
| 20040323 | Product specification | - | TJA1054A_2 |
| 20020211 | Product specification | - | TJA1054A_1 |
| 20010820 | Preliminary specification | - | - |
| | 20100803 • Value of para • Typing error 20070102 20040323 20020211 | 20100803 Product data sheet • Value of parameter V _{ESD} (machine model) • Typing error corrected in <u>Table 8</u> in the conduct data sheet 20070102 Product data sheet 20040323 Product specification 20020211 Product specification | Product data sheet Value of parameter V _{ESD} (machine model) changed in Table 6 a Typing error corrected in Table 8 in the conditions column for I _B Product data sheet Product specification Product specification Product specification |

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19. Legal information

19.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

19.2 Definitions

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